



Product Change Notification

110612 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 110612 - 00
Change Title: Intel® Desktop Board DX58OG, Boxed and Bulk
PCN 110612-00, Product Design
Added two 10uF capacitors at locations PC217 and PC219 to enhance CPU voltage regulator performance
Date of Publication: May 06, 2011

Key Characteristics of the Change:

Product Design

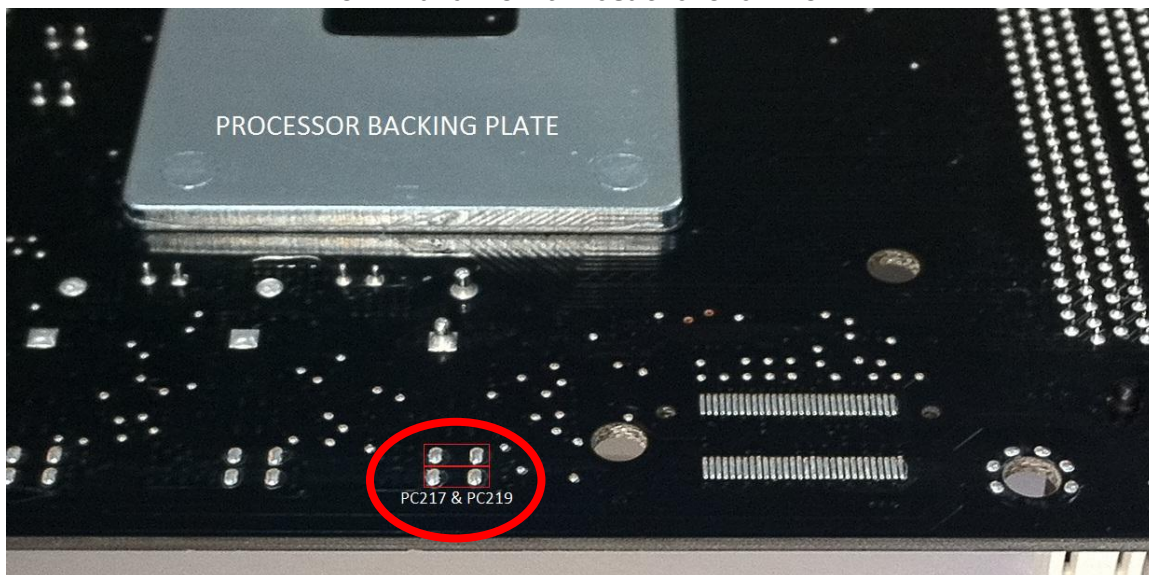
Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 19, 2011
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Description of Change to the Customer:

Added two 10uF capacitors at locations PC217 and PC219 to enhance CPU voltage regulator performance.

PC217 and PC219 Locations on PCB



Customer Impact of Change and Recommended Action:

This change has been thoroughly evaluated to ensure that there are no quality, reliability or functional implications to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change AA	Post Change AA
BOXDX58OG	908532	G10926-204	G10926-205
BLKDX58OG	908535	G10926-204	G10926-205

PCN Revision History:

Date of Revision:

May 6, 2011

Revision Number:

00

Reason:

Originally Published PCN